

#### **Features**

- Top view 1016 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright White
- RoHS compliance

### **Applications**

- Optical indicator.
- Switch and Symbol Display.

### **Description**

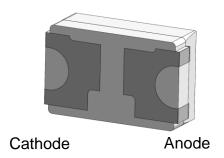
The WC101606-ETC4 is an AllnGaN White LED housed in a miniature SMD package.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs

### **Package Outline**





#### **Schematic**



### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	30	mA	
I <sub>FP</sub>	Peak Forward Current	90	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	2
P <sub>D</sub>	Power Dissipation at(or below) 25°C Free Air Temperature	115	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =30mA	2250	-	3600	mcd	3
θ1/2	Angle of Half Intensity	I <sub>F</sub> =30mA	-	±60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =30mA	2.9	-	3.7	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μΑ	

#### Notes:

- 1. I<sub>FP</sub> Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
X2	2250	2850	mad	L 20m A
Y1	2850	3600	mcd	I <sub>F</sub> =30mA

Tolerance of Luminous Intensity  $\pm 10\%$ 



#### 4. Bin Range of Forward Voltage

Bin Code	Min	Max	Unit	Condition	
V10	2.9	3.1			
V11	3.1	3.3	V	I <sub>F</sub> =30mA	
V12	3.3	3.5	V		
V13	3.5	3.7			

Tolerance of Forward Voltage  $\pm 0.1 \text{V}$ 

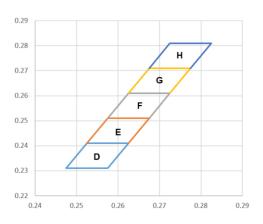
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#### 5. Bin Range of Chromaticity Coordinates

Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2475	0.2310		0.2525	0.2410
	0.2525	0.2410	_	0.2575	0.2510
D	0.2625	0.2410	E	0.2675	0.2510
	0.2575	0.2310	-	0.2625	0.2410
	0.2575	0.2510	G	0.2625	0.2610
F	0.2625	0.2610		0.2675	0.2710
ļ r	0.2725	0.2610		0.2775	0.2710
	0.2675	0.2510		0.2725	0.2610
	0.2675	0.2710			
н	0.2725	0.2810			
"	0.2825	0.2810			
	0.2775	0.2710			

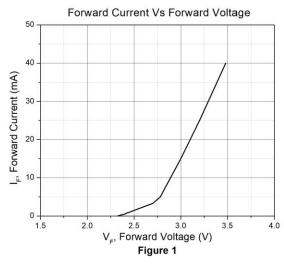
Tolerance of Chromaticity Coordinates: ±0.01

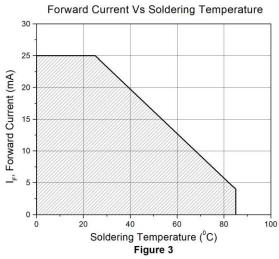
### The C.I.E. 1931 Chromaticity Diagram

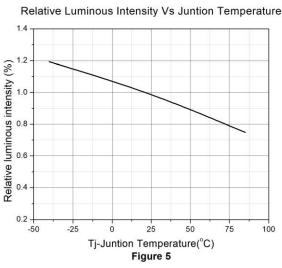


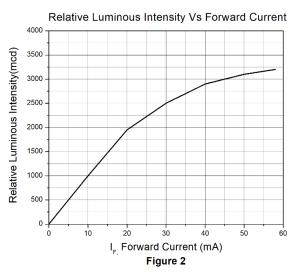


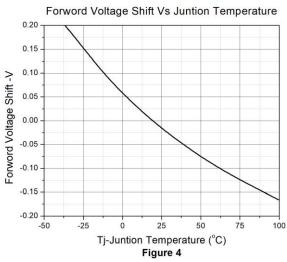
## **Typical Characteristic Curves**

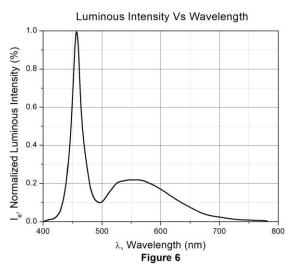






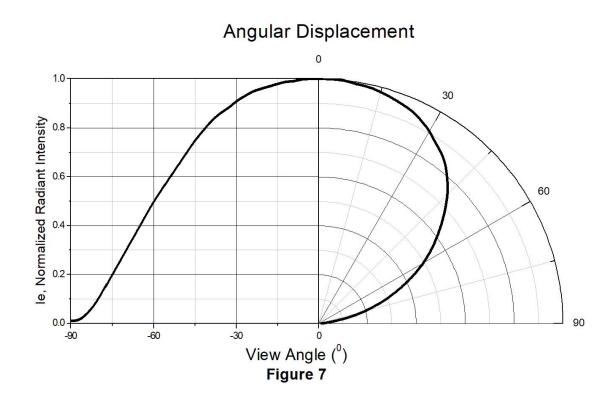






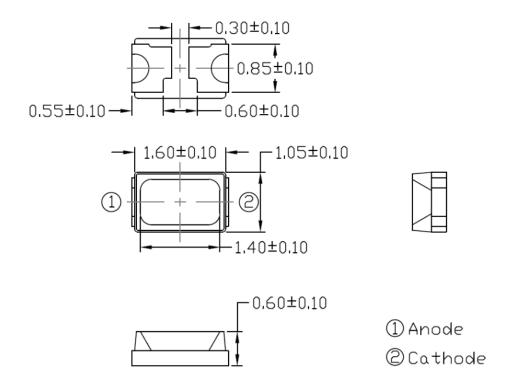


### **Typical Characteristic Curves**



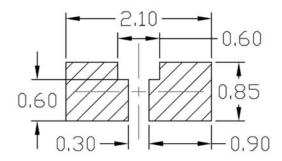


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



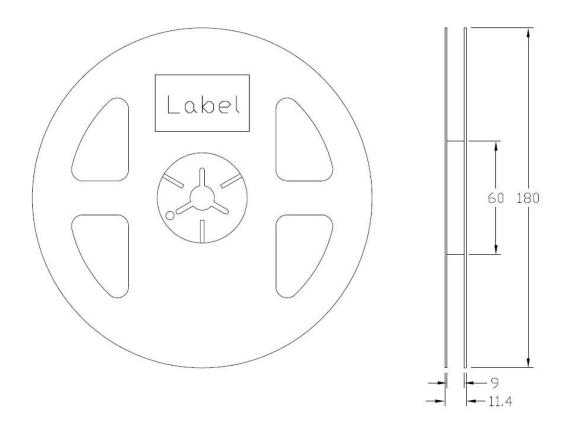
Note: Tolerance unless mentioned is ±0.1mm.

## **Ordering Information**

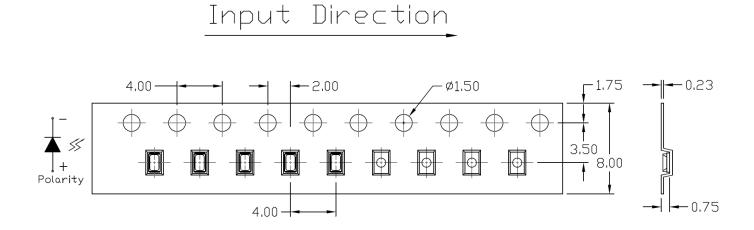
Part Number	Description	Quantity
WC101606-ETC4	Tape & Reel	4000 pcs



#### Reel Dimension All dimensions are in mm, unless otherwise stated



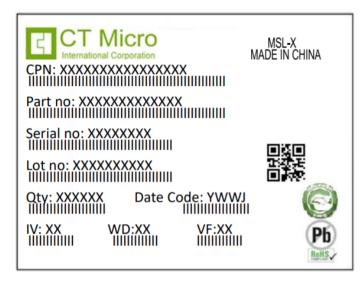
### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



### **Label Form Specification**



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD: Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

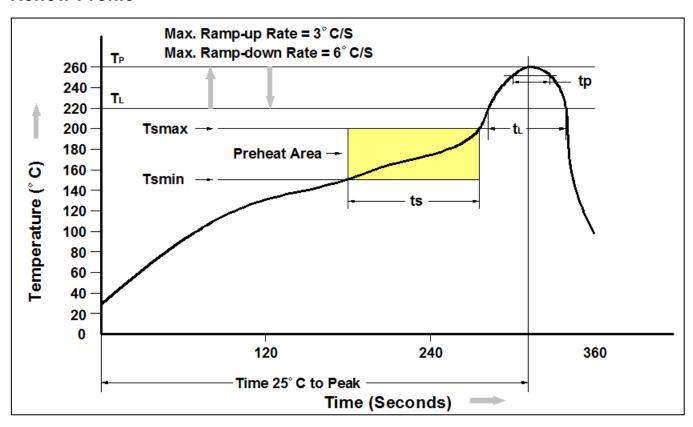
MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T∟)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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